

1. SCOPE

This specification shall cover the characteristics of the ceramic filter with the type LT10.7MS3.

2. PART NO.:

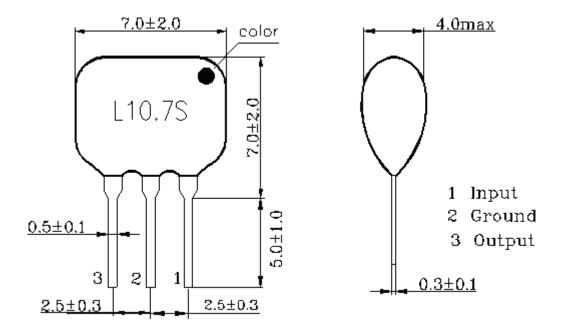
PART NUMBER	CUSTOMER PART NO	SPECIFICATION NO
LT10.7MS3		

# 3. OUTLINE DRAWING AND STRUCTURE:

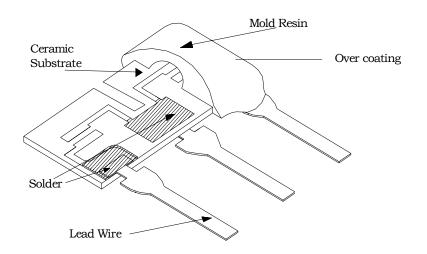
Appearance: No visible damage and dirt.

Construction: Leads are soldered on electrode and body is molded by resin.

Dimensions (mm) :







# 3.4 STRUCTURE

Component	Material
Lead Wore	Solder plating copper wire
Mold Resin	epoxy resin
Solder	High-melting solder (No Pb)
Ceramic Substrate	Lead titanate-zirconate
Over coating	Clear Epoxy Resin

# 4. RATING AND ELECTRICAL SPECIFICATIONS:

#### 4.1 RATING

Items	Content
Withstand DC Voltage max	50V 1minute
Applied DC voltage max	10V
Operating temperature	-20°C~80°C
Temp. Coefficient of Frequency (%) max	±0.5 (Center Frequency drift, -20°C~80°C)
Storage temperature range	-40°C~80°C



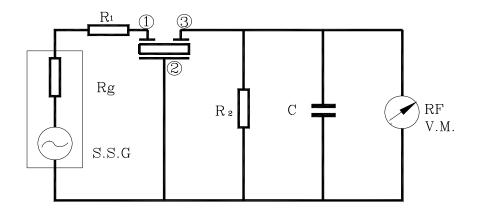
Items	Content
Center Frequency fo (MHz)	$10.700 \pm 0.030$ (Red) $10.670 \pm 0.030$ (Blue)
	10.730±0.030(Orange)
3dB Band Width (kHz)	$180 \pm 40$
20dB Band Width (kHz) max	520
Insertion Loss (dB) max	7.0
Ripple (within 3dB bandwidth) % max	1.0
Spurious Response (dB) min	40 (9 MHz ~12MHz)
Input/Output Impedance ( $\Omega$ )	330

### 5. MEASUREMENT:

Measurement Conditions:

Parts shall be measured under a condition (Temp.:  $20 \degree C$  ±15  $\degree C$ , Humidity :  $65\%\pm20\%$  R.H.) unless the standard condition(Temp.:  $25\degree C\pm3\degree C$ , Humidity :  $65\%\pm5\%$  R.H.) is regulated to measure.

Test Circuit:



#### $Rg+R1=R2=330 \Omega$

C=10pF(Including stray capacitance and input capacitance of RF voltmeter)



No	Item	Condition of Test	Performance Requirements
6.1	Humidity	Subject the filter at $(60 \pm 2)$ °C and 90%~95% R.H. for 100 hours, filter shall be measured after being placed in natural conditions for 1 hour.	It shall fulfill the specifications in Table 1.
6.2	High Temperature Exposure	Subject the filter to $(85 \pm 5)$ °C for 100 hours, filter shall be measured after being placed in natural conditions for 1 hour.	It shall fulfill the specifications in Table 1.
6.3	Low Temperature Exposure	Subject the filter to $(-40\pm5)^{\circ}$ C for 100 hours, filter shall be measured after being placed in natural conditions for 1 hour.	It shall fulfill the specifications in Table 1.
6.4	Thermal shock	After temperature cycling of blow table wasperformed 5 times, filter shall be measured afterbeing placed in natural conditions for 1 hour.TemperatureTime1 $(-40\pm3)^{\circ}$ C(30\pm3) mins2Room temp.5 S3 $(+85\pm3)^{\circ}$ C(30±3) mins4Room temp.5 S	It shall fulfill the specifications in Table 1.
6.5	Vibration	Subject the filter to vibration for 2 hours each in x y and z axis with the amplitude of 1.5mm, the frequency shall be varied uniformly between the limits of 10Hz~55Hz and then filter shall be measured.	It shall fulfill the specifications in Table 1.
6.6	Mechanical Shock test	Apply the half-sine shock pulses: $981 \text{m/s}^2$ ,6ms for 3 times in each direction of three mutually perpendicular planes.	No visible damage and it shall fulfill the specifications in Table 1.
6.7	Drop test	Filter shall be measured after 3 times random dropping from the height of 1m on concrete floor.	No visible damage and it shall fulfill the specifications in Table 1.

# 6 PHYSICAL AND ENVIRONMENTAL CHARACTERISTICS

http://www.luguang.cn Email: lge@luguang.cn

# 6 PHYSICAL AND ENVIRONMENTAL CHARACTERISTICS

		(Continued from	n the preceding page)
No	Item	Condition of Test	Performance
110	nem	condition of fest	Requirements
6.8	Resistance to Soldering Heat	Lead terminals are immersed up to 2 mm from filter's body in soldering bath of $(+260\pm5)^{\circ}$ C for $(10\pm1)$ seconds and then filter shall be measured after being placed in natural conditions for 1 hour.	It shall fulfill the specifications in Table 1.
6.9	Short time heat resistance	Store in $(+160\pm2)^{\circ}$ for 2 min and then filter shall be measured after being placed in natural conditions for 1 hour.	It shall fulfill the specifications in Table 1.
6.10	Solderability	Lead terminals are immersed up to 2mm from filter's body in soldering bath of $(+250\pm5)^{\circ}$ C for $(2\pm0.5)$ seconds.	More than 95% of the terminal surface of the filter shall be covered with fresh solder.
6.11	Terminal		
	Strength	Force of 4.9N is applied to each lead in	
6.11.1	Terminal	axial direction for $(10 \pm 1)$ seconds.	No visible damage
	Pulling	When force of 4.9N is applied to each lead	and it shall fulfill
6.11.2	Terminal	in axial direction, the lead shall folded up	the specifications
	Bending	$90^{\circ}$ from the axial direction and folded	in Table 1.
		back to the axial direction. The speed of	
		folding shall be each 3 seconds.	

(Continued from the preceding page)

|--|

Item	Specification after test
Center Frequency drift	$\pm$ 30kHz max
Insertion Loss drift	$\pm 2$ dB max.
3dB Band Width drift	$\pm 20$ kHz max.
20dB Band Width drift	$\pm$ 30kHz max.
Spurious Response	25 dB min

Note : The limits in the above table are referenced to the initial measurements.



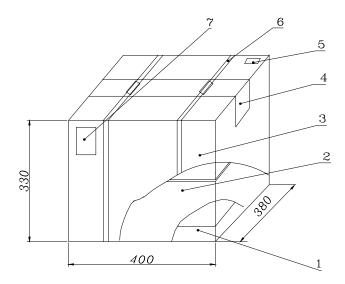
## 7 PACKAGE

To protect the products in storage and transportation, it is necessary to pack them(outer and inner package).On paper pack, the following requirements are requested.

7.1 Dimensions and Mark

At the end of package, the warning (moisture proof, upward put) should be stick to it.

Dimensions and Mark (see below)



NO.	Name	Quantity	Notes
1	Inner Box	40	
2	Box	2	
3	Package	1	
4	Adhesive tape	1.2m	
5	Label	1	
6	Belt	2.9m	
7	Certificate of approval	1	



7.2 Section of package

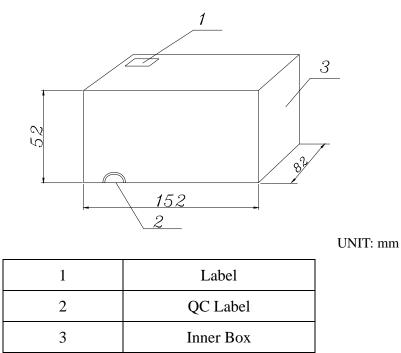
Package is made of corrugated paper with thickness of 0.8cm.Package has 2 inner boxes, each has 20 inner boxes (each box for plastic bag).

7.3Quantity of package

Per plastic bag	500 pieces	
Per inner box	3 plastic bag	
Per package	40 inner boxes (60000 pieces	of

piezoelectric ceramic part )

7.4Inner box Dimensions



Pars shall be packaged in box with hold down tape upside. Part No., quantity and lot No.



### 8 OTHER

8.1 Caution of use

8.1.1 Do not use this product with bend. Please don't apply excess mechanical stress to the component and terminals at soldering.

8.1.2 The component may be damaged when an excess stress will be applied.

8.1.3 This specification mentions the quality of the component as a single unit. Please insure the component is thoroughly evaluated in your application circuit.

8.2 Notice

8.2.1 Please return one of this specification after your signature of acceptance.

8.2.2 When something gets doubtful with this specifications, we shall jointly work to get an agreement.